PCN Number: 20180531003 PCN Date: June 15, 2018						
Title: Datasheet for TXB0106-Q1						
Customer Contact: PCN Manage			De	pt:	Quality Services	
Change Type:						
Assembly Site	Desig				Bump Site	
Assembly Process		Data Sheet			Bump Material	
Assembly Materials Mechanical Specification		number change		Wafer Bump Process Wafer Fab Site		
Packing/Shipping/Labeling	Test	Process	H		Fab Site Fab Materials	
Tracking/Shipping/Labeling		110003	TH		Fab Process	
Notification Details						
Description of Change:						
Texas Instruments Incorporated is announcing an information only notification.						
The product datasheet(s) is being updated as summarized below. The following change history provides further details.						
	ues fui tile	i details.				
TEXAS INSTRUMENTS					TXB0106-Q1	
			SCES	S791A – AUG	GUST 2009-REVISED APRIL 2018	
Changes from Original (August 2009) to	Revision A				Page	
 Added Applications section, ESD Ratings table, Feature Description section, Device Functional Modes section, 						
Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section						
Changed the entry in the TYPE column from "—" to "I" for V _{CCA} and V _{CCB}						
Added row for junction temperature to Absolute Maximum Ratings						
Added parameter descriptons to Electrical Characteristics table						
Added "-Q1" to the device name throughout the document						
Changed I to I _{CC} in Output Load Considerations. 15						
Changed TXS01xx series to TXS family in Pullup or Pulldown Resistors on I/O Lines						
Changed TXS010X to TXS in Application Information						
To claimed wording of sentences and added references to two application reports						
The datasheet number will be char	naina.					
Device Family		Change From:		Change	e To:	
TXB0106-Q1		SCES791		SCES791A		
These changes may be reviewed a	t the data	sheet links provided	•			
,		sneet iinks provided.				
http://www.ti.com/product/TXB01	<u>06-Q1</u>					
Reason for Change:						
To accurately reflect device charac	teristics.					
Anticipated impact on Fit, Forn	ı, Functio	on, Quality or Relia	bilit	y (posi	tive / negative):	
No anticipated impact. This is a sp to the actual device.	ecification	change announceme	ent o	only. The	ere are no changes	
Changes to product identification resulting from this PCN:						
None.						
Product Affected:						
TXB0106IPWRQ1						
		•		•		

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com